



CY7C383A
CY7C384A

UltraLogic™ Very High Speed 2K Gate CMOS FPGA

Features

- **Very high speed**
 - Loadable counter frequencies greater than 150 MHz
 - Chip-to-chip operating frequencies up to 110 MHz
 - Input + logic cell + output delays under 6 ns
- **Unparalleled FPGA performance** for counters, data path, state machines, arithmetic, and random logic
- **High usable density**
 - 12 x 16 array of 192 logic cells provides 6,000 total available gates
 - 2,000 typically usable "gate array" gates in 68- and 84-pin PLCC, 85-pin CPGA, and 100-pin TQFP packages
- **Low power, high output drive**
 - Standby current typically 2 mA
 - 16-bit counter operating at 150 MHz consumes 50 mA
 - Minimum I_{OL} of 12 mA and I_{OH} of 8 mA
- **Flexible logic cell architecture**
 - Wide fan-in (up to 14 input gates)
 - Multiple outputs in each cell
 - Very low cell propagation delay (1.7 ns typical)
- **Powerful design tools—Warp3™**
 - Designs entered in VHDL, schematics, or both
 - Fast, fully automatic place and route
- Waveform simulation with back annotated net delays
- PC and workstation platforms
- **Extensive 3rd party tool support**
 - See Development Systems section
- **Robust routing resources**
 - Fully automatic place and route of designs using up to 100 percent of logic resources
 - No hand routing required
- **56 (CY7C383A) to 80 (CY7C384A) bidirectional input/output pins**
- **6 dedicated input/high-drive pins**
- **2 clock/dedicated input pins with fan-out-independent, low-skew nets**
 - Clock skew < 0.5 ns
- **Input hysteresis provides high noise immunity**
- **Thorough testability**
 - Built-in scan path permits 100 percent factory testing of logic and I/O cells
- **0.65µ CMOS process with ViaLink™ programming technology**
 - High-speed metal-to-metal link
 - Non-volatile antifuse technology
- **68-pin PLCC is pinout compatible with 1K (CY7C382P) devices**
- **84-pin PLCC is pinout compatible with the 4K (CY7C385P) devices**
- **100-pin TQFP is pinout compatible with the 1K (CY7C382P) and the 4K (CY7C385P) devices**

Functional Description

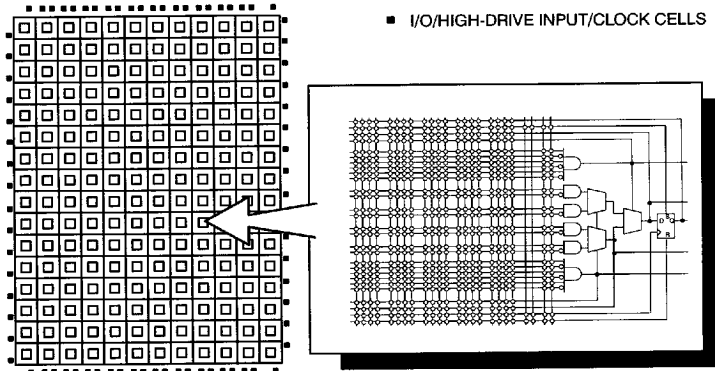
The CY7C383A and CY7C384A are very high speed CMOS user-programmable ASIC (pASIC™) devices. The 192 logic cell field-programmable gate array (FPGA) offers 2,000 typically usable "gate array" gates. This is equivalent to 6,000 EPLD or LCA gates. The CY7C383A is available in a 68-pin PLCC package. The CY7C384A is available in 84-pin PLCC, 85-pin CPGA and 100-pin TQFP packages.

Low-impedance, metal-to-metal ViaLink interconnect technology provides non-volatile custom logic capable of operating at speeds above 150 MHz with input delays under 1.5 ns and output delays under 3 ns. This permits high-density programmable devices to be used with today's fastest CISC and RISC microprocessors.

Designs are entered into the CY7C383A and CY7C384A using Cypress *Warp3* software or one of several third-party tools. See the Development Systems section of the *Programmable Logic Data Book* for more tools information. *Warp3* is a sophisticated CAE package that features schematic entry, waveform-based timing simulation, and VHDL design synthesis. The CY7C383A and CY7C384A feature ample on-chip routing channels for fast, fully automatic place and route of high gate utilization designs.

For detailed information about the pASIC380 architecture, see the pASIC380 Family datasheet.

Logic Block Diagram

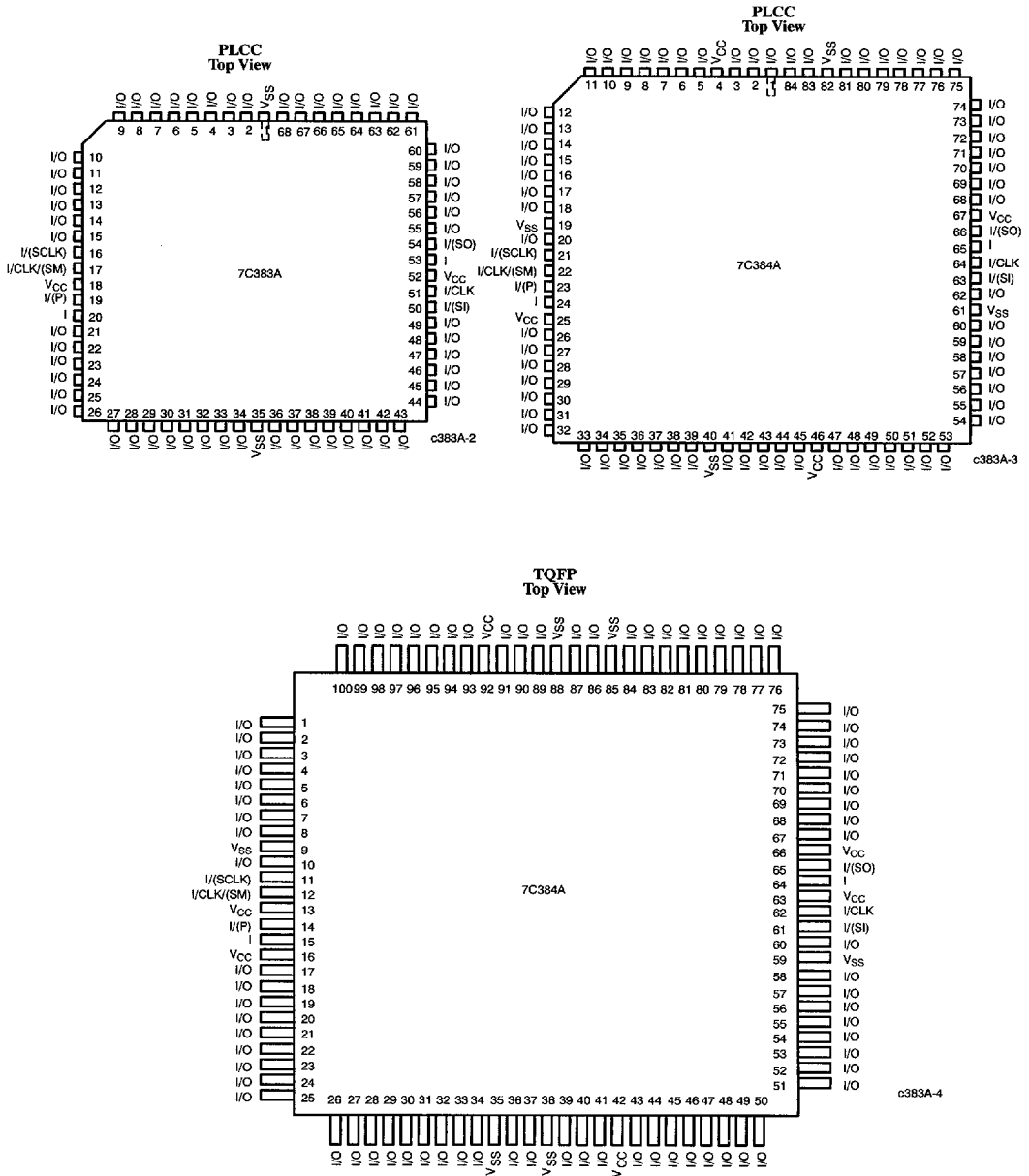


68, 84(85), or 100 PINS, INCLUDING 68 I/O CELLS, 6 INPUT HIGH-DRIVE CELLS, 2 INPUT/CLK (HIGH-DRIVE) CELLS

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Pin Configurations



Pin Configurations (continued)
**CPGA
Bottom View**

I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	A
I/O	I/O	I/O	I/O	I/(SCLK)	I/(P)	I	I/O	I/O	I/O	I/O	B
I/O	I/O			V _{SS}	I/CLK (SM)	V _{CC}		■	I/O	I/O	C
I/O	I/O								I/O	I/O	D
I/O	I/O	V _{CC}						V _{SS}	I/O	I/O	E
I/O	I/O	I/O						I/O	I/O	I/O	F
I/O	I/O	V _{SS}						V _{CC}	I/O	I/O	G
I/O	I/O								I/O	I/O	H
I/O	I/O			V _{CC}	I/CLK	V _{SS}			I/O	I/O	J
I/O	I/O	I/O	I/O	I/(SO)	I	I/(SI)	I/O	I/O	I/O	I/O	K
I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	L
11	10	9	8	7	6	5	4	3	2	1	

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Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	
Ceramic	-65°C to +150°C
Plastic	-40°C to +125°C
Lead Temperature	300°C
Supply Voltage	-0.5V to +7.0V
Input Voltage	-0.5V to V _{CC} + 0.5V
ESD Pad Protection	±2000 V
DC Input Voltage	-0.5V to +7.0V

DC Input Current	±20 mA
Latch-Up Current	±200 mA

Operating Range

Range	Ambient Temperature	V _{CC}
Commercial	0°C to +70°C	5V ± 5%
Industrial	-40°C to +85°C	5V ± 10%
Military	-55°C to +125°C	5V ± 10%

Delay Factor (K)

Speed Grade	Military		Industrial		Commercial	
	Min.	Max.	Min.	Max.	Min.	Max.
-X	0.39	3.00	0.4	2.75	0.46	2.55
-0	0.39	1.82	0.4	1.67	0.46	1.55
-1	0.39	1.56	0.4	1.43	0.46	1.33
-2			0.4	1.35	0.46	1.25

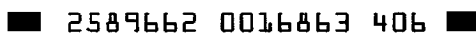
Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = -4.0 mA	3.7		V
		I _{OH} = -8.0 mA	2.4		V
		I _{OH} = -10.0 μA	V _{CC} - 0.1		V
V _{OL}	Output LOW Voltage	I _{OL} = 12 mA Commercial		0.4	V
		I _{OL} = 8.0 mA Military/Industrial			V
		I _{OL} = 10.0 μA		0.1	V
V _{IH}	Input HIGH Voltage		2.0		V
V _{IL}	Input LOW Voltage			0.8	V
I _I	Input Leakage Current	V _{IN} = V _{CC} or V _{SS}	-10	+10	μA
I _{OZ}	Output Leakage Current—Three-State	V _{IN} = V _{CC} or V _{SS}	-10	+10	μA
I _{OS}	Output Short Circuit Current ^[1]	V _{OUT} = V _{SS}	-10	-80	mA
		V _{OUT} = V _{CC}	30	140	mA
I _{CC1}	Standby Supply Current	V _{IN} , V _{IO} = V _{CC} or V _{SS}		10	mA

Capacitance

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance ^[2]	T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V	10	pF
C _{OUT}	Output Capacitance		10	pF

- Notes:
 1. Only one output at a time. Duration should not exceed 30 seconds.
 2. C_{IN} = 40 pF max. on I(SI) and I(P).



Switching Characteristics (At $V_{CC}=5V, T_A=25^\circ C, K=1.00$)

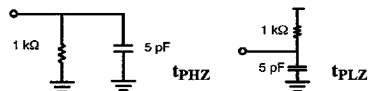
Parameter	Description	Propagation Delays ^[3] with Fanout of					Unit
		1	2	3	4	8	
LOGIC CELLS							
t _{PD}	Combinatorial Delay ^[4]	1.7	2.2	2.6	3.2	5.2	ns
t _{SU}	Set-Up Time ^[4]	2.1	2.1	2.1	2.1	2.1	ns
t _H	Hold Time	0.0	0.0	0.0	0.0	0.0	ns
t _{CLK}	Clock to Q Delay	1.0	1.5	1.9	2.5	4.6	ns
t _{CWHI}	Clock HIGH Time	2.0	2.0	2.0	2.0	2.0	ns
t _{CWLO}	Clock LOW Time	2.0	2.0	2.0	2.0	2.0	ns
t _{SET}	Set Delay	1.7	2.1	2.6	3.2	5.2	ns
t _{RESET}	Reset Delay	1.5	1.9	2.2	2.7	4.3	ns
t _{SW}	Set Width	1.9	1.9	1.9	1.9	1.9	ns
t _{RW}	Reset Width	1.8	1.8	1.8	1.8	1.8	ns

Parameter	Description	Propagation Delays ^[3]						Unit
		1	2	3	4	6	8	
INPUT CELLS								
t _{IN}	Input Delay (HIGH Drive)	2.4	2.5	2.6	2.7	3.0	3.3	ns
t _{INI}	Input, Inverting Delay (HIGH Drive)	2.5	2.6	2.7	2.8	3.1	3.4	ns
t _{IO}	Input Delay (Bidirectional Pad)	1.4	1.9	2.2	2.8	3.7	4.6	ns
t _{GCK}	Clock Buffer Delay ^[5]	2.7	2.8	2.8	2.9	2.9	3.0	ns
t _{GCKHI}	Clock Buffer Min. HIGH ^[5]	2.0	2.0	2.0	2.0	2.0	2.0	ns
t _{GCKLO}	Clock Buffer Min. LOW ^[5]	2.0	2.0	2.0	2.0	2.0	2.0	ns

Parameter	Description	Propagation Delays ^[3] with Output Load Capacitance (pF) of					Unit
		30	50	75	100	150	
OUTPUT CELLS							
t _{OUTLH}	Output Delay LOW to HIGH	2.7	3.4	4.2	5.0	6.7	ns
t _{OUTHL}	Output Delay HIGH to LOW	2.8	3.7	4.7	5.6	7.6	ns
t _{PZH}	Output Delay Three-State to HIGH	4.0	4.9	6.1	7.3	9.7	ns
t _{PZL}	Output Delay Three-State to LOW	3.6	4.2	5.0	5.8	7.3	ns
t _{PHZ}	Output Delay HIGH to Three-State ^[6]	2.9					ns
t _{PLZ}	Output Delay LOW to Three-State ^[6]	3.3					ns

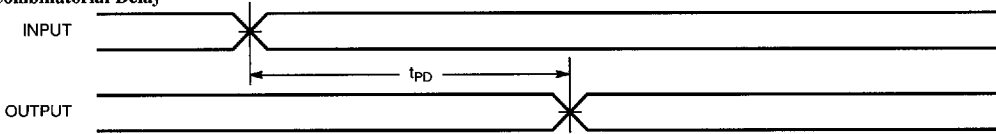
Notes:

- Worst-case propagation delay times over process variation at $V_{CC} = 5.0V$ and $T_A = 25^\circ C$. Multiply by the appropriate delay factor, K , for speed grade to get worst-case parameters over full V_{CC} and temperature range as specified in the operating range. All inputs are TTL with 3-ns linear transition time between 0 and 3 volts.
- These limits are derived from worst-case values for a representative selection of the slowest paths through the pASIC380 logic cell including net delays. Guaranteed delay values for specific paths should be determined from simulation results.
- Clock buffer fanout refers to the maximum number of flip-flops per half column. The number of half columns used does not affect clock buffer delay.
- The following loads are used for t_{PXZ} :

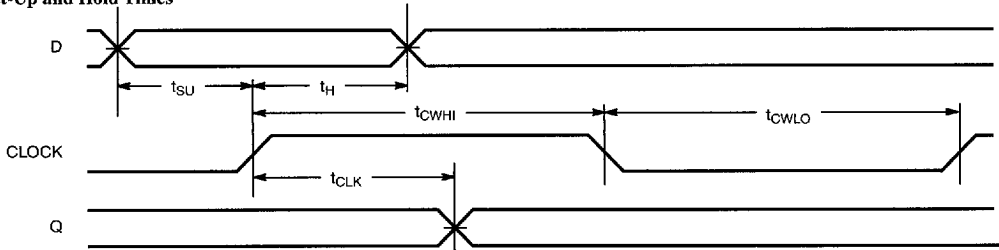


High Drive Buffer

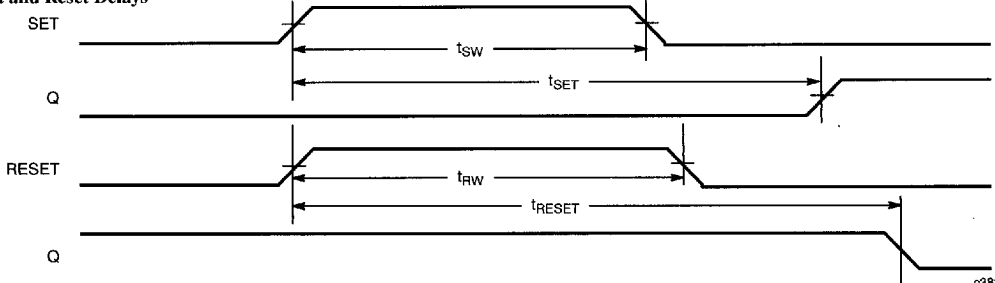
Parameter	Description	# High Drives Wired Together	Propagation Delays ^[3] with Fanout of					Unit
			12	24	48	72	96	
t_{IN}	High Drive Input Delay	1	4.5	5.4				ns
		2		3.9	5.6			ns
		3			4.5	5.3	6.3	ns
		4				4.6	5.3	ns
t_{NI}	High Drive Input, Inverting Delay	1	4.7	5.6				ns
		2		4.0	5.8			ns
		3			4.6	5.5	6.4	ns
		4				4.8	5.5	ns

Switching Waveforms
Combinatorial Delay


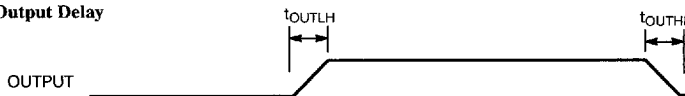
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Set-Up and Hold Times


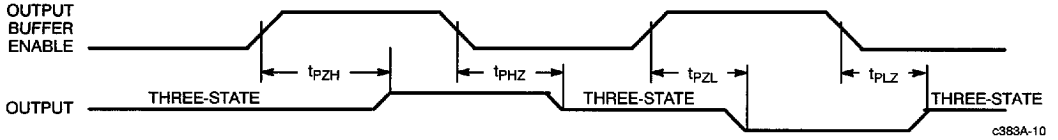
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Set and Reset Delays


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Output Delay


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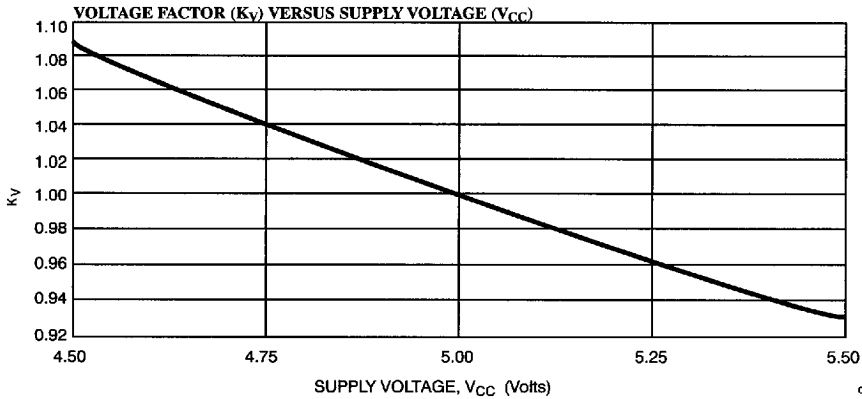
Switching Waveforms (continued)
Three-State Delay


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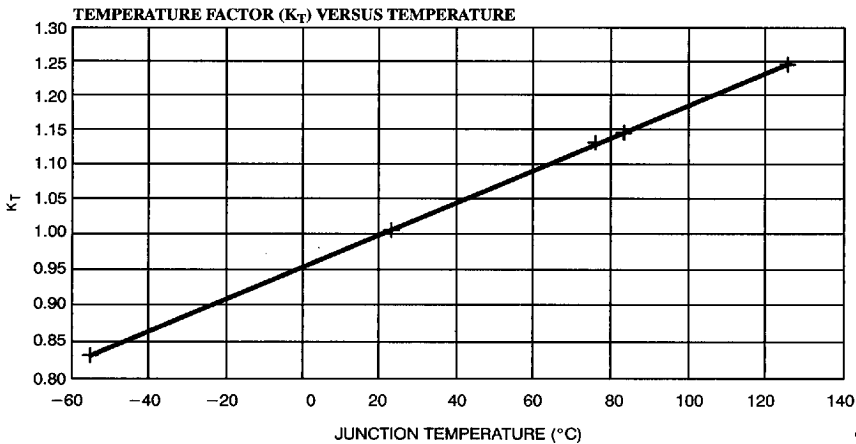
Typical AC Characteristics

Propagation delays depend on routing, fan-out, load capacitance, supply voltage, junction temperature, and process variation. The AC Characteristics are a design guide to provide initial timing estimates at nominal conditions. Worst-case estimates are obtained when nominal propagation delays are multiplied by the appropriate

Delay Factor, K , as specified by the speed grade in the Delay Factor table. The effects of voltage and temperature variation are illustrated in the graphs below. The *Warp3* Delay Modeler extracts specific timing parameters for precise simulation results following place and route.



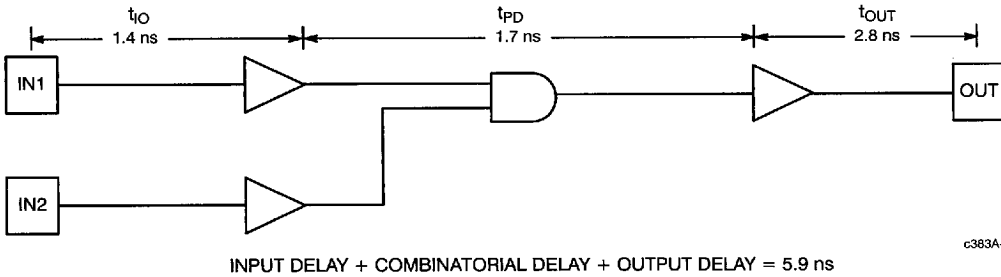
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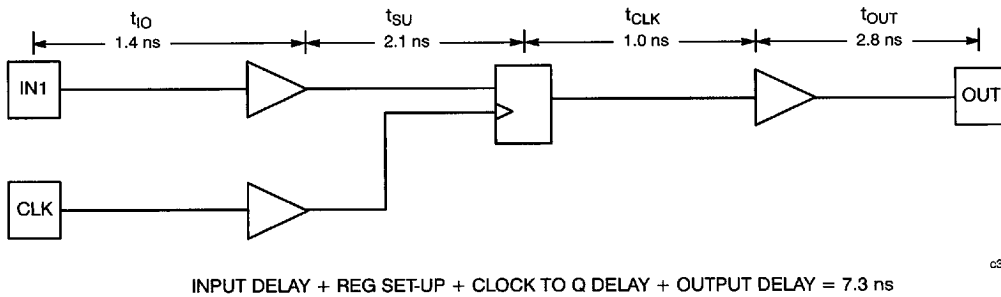
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 * $\theta_{JA} = 45 \text{ }^\circ\text{C/WATT FOR PLCC}$

Combinatorial Delay Example (Load = 30 pF, K=1, Fanout=1)



Sequential Delay Example (Load = 30 pF, K=1, Fanout=1)



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Ordering Information

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
2	CY7C383A-2JC	J81	68-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C383A-2JI	J81	68-Lead Plastic Leaded Chip Carrier	Industrial
1	CY7C383A-1JC	J81	68-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C383A-1JI	J81	68-Lead Plastic Leaded Chip Carrier	Industrial
0	CY7C383A-0JC	J81	68-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C383A-0JI	J81	68-Lead Plastic Leaded Chip Carrier	Industrial
X	CY7C383A-XJC	J81	68-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C383A-XJI	J81	68-Lead Plastic Leaded Chip Carrier	Industrial

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
2	CY7C384A-2AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C384A-2JC	J83	84-Lead Plastic Leaded Chip Carrier	
	CY7C384A-2AI	A100	100-Pin Thin Quad Flat Pack	Industrial
	CY7C384A-2JI	J83	84-Lead Plastic Leaded Chip Carrier	
1	CY7C384A-1AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C384A-1JC	J83	84-Lead Plastic Leaded Chip Carrier	
	CY7C384A-1AI	A100	100-Pin Thin Quad Flat Pack	Industrial
	CY7C384A-1JI	J83	84-Lead Plastic Leaded Chip Carrier	
0	CY7C384A-1GMB	G85	85-Pin Grid Array (Cavity Up)	Military
	CY7C384A-0AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C384A-0JC	J83	84-Lead Plastic Leaded Chip Carrier	
	CY7C384A-0AI	A100	100-Pin Thin Quad Flat Pack	Industrial
CY7C384A-0JI	J83	84-Lead Plastic Leaded Chip Carrier		
X	CY7C384A-0GMB	G85	85-Pin Grid Array (Cavity Up)	Military
	CY7C384A-XAC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C384A-XJC	J83	84-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C384A-XAI	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C384A-XJI	J83	84-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C384A-XGMB	G85	85-Pin Grid Array (Cavity Up)	Military

Shaded area contains preliminary information.

MILITARY SPECIFICATIONS
Group A Subgroup Testing

DC Characteristics

Parameter	Subgroups
V _{OH}	1, 2, 3
V _{OL}	1, 2, 3
I _{OZ}	1, 2, 3
I _{CCI}	1, 2, 3

Document #: 38-00361-B